

GOMACTech-10 CONFERENCE SCHEDULE

		PEPPERMILL HOTEL, RENO, NEVADA							
	GOMACTech Timetable	Tuscany Ballroom Foyer	Tuscany C	Tuscany 9	Tuscany 10	Tuscany 11	GOMACTech Timetable		
Monday, 22 March	7:00–8:30 am	Tutorial 1 Only Registration	7:00–8:30 am	Monday, 22 March	
	8:30–12:00 pm	Tutorial 1 Trusted Suppliers Summit	8:30–12:00 pm		
	9:00–5:00 pm	General Registration	9:00–5:00 pm		
	LUNCH 12:00–1:00 pm	TUTORIAL 1 LUNCH (Tuscany 10)	LUNCH 12:00–1:00 pm		
	1:00–5:00 pm	Tutorial 1 continued Trusted Suppliers Summit	Tutorial 2 Anti-Tamper (Tuscany 11)	Tutorial 3 Need for MILSPEC Parts (Tuscany 12)	1:00–5:00 pm		
Tuesday, 23 March	7:00–5:00 pm	Registration	7:00–5:00 pm	Tuesday, 23 March	
	8:30–10:00 am	PLENARY SESSION Introductory Comments, Awards, Keynote Address: Zach Lemnios, DDR&E Dir.	8:30–10:00 am		
	BREAK 10:00–10:30 am	BREAK			BREAK 10:00–10:30 am		
	10:30–12:00 pm	KILBY LECTURES	10:30–12:00 pm		
	LUNCH 12:00–1:30 pm	Exhibits (12:00–8:00 pm)	LUNCH (Tuscany AB Ballroom)			LUNCH 12:00–1:30 pm		
	1:30–3:00 pm	Session 1 Phased Array Antenna Technology I	Session 2 Graphene FET Electronics	Session 3 Advances in Wide Bandgap Semiconductors for Military Applications	1:30–3:00 pm		
	BREAK 3:00–3:30 pm	BREAK			BREAK 3:00–3:30 pm		
	3:30–5:00 pm	Session 4 Phased Array Antenna Technology II	Session 5 Graphene RF Electronics	Session 6 High Power Digital-to Analog Conversion	3:30–5:00 pm		
6:00–8:00 pm	EXHIBIT RECEPTION (Tuscany AB Ballroom)					6:00–8:00 pm		
Wednesday, 24 March	7:00–5:00 pm	Registration	7:00–5:00 pm	Wednesday, 24 March	
	8:30–10:00 am	Session 7 Power Electronic Technologies I	Session 8 Advanced RF Power Amplifiers	Session 9 Integrated Silicon RF Electronics I	8:30–10:00 am		
	BREAK 10:00–10:30 am	BREAK			BREAK 10:00–10:30 am		
	10:30–12:00 pm	Session 10 Power Electronic Technologies II	Session 11 Carbon Nanotubes Electronics	Session 12 Integrated Silicon RF Electronics II	10:30–12:00 pm		
	LUNCH 12:00–1:30 pm	Exhibits (8:00–3:30 pm)	LUNCH (Tuscany AB Ballroom) Keynote Speaker - Kit Parker			LUNCH 12:00–1:30 pm		
	1:30–3:10 pm	Session 13 Radiation Hardened Microelectronics - Basic Mechanisms	Session 14 Trusted Systems from Untrusted Components (1:30–3:00 pm)	Session 15 RF Tags (1:30–3:00 pm)	1:30–3:10 pm		
	BREAK 3:00–3:30 pm	BREAK			BREAK 3:00–3:30 pm		
	3:30–5:10 pm	Session 16 Radiation Hardened Microelectronics - Design	Session 17 Microwave Systems Diagnostics	Session 18 Piezo MEMS (3:00–5:00 pm)	3:00–5:10 pm		
6:00 pm	WEDNESDAY EVENING SOCIAL Dinner TBD (separate registration fee)					6:00 pm		
Thursday, 25 March	7:00–3:00 pm	Registration	7:00–3:00 pm	Thursday, 25 March	
	8:30–10:00 am	Poster Sessions 28 and 29 (9:00–12:00 pm)	Session 19 Trusted Defense Systems	Session 20 Communications and Infrastructure Networks	Session 21 Energy Scavenging for Unattended Sensor	8:30–10:00 am		
	BREAK 10:00–10:30 am	BREAK			BREAK 10:00–10:30 am		
	10:30–12:00 pm	Session 22 On Chip Authentication & Identification	Session 23 3-Dimensional Integrated Circuits	Session 24 Space Power Systems	10:30–12:00 pm		
	LUNCH 12:00–1:30 pm	LUNCH (Tuscany AB Ballroom) Keynote Speaker - Jim Gosler			LUNCH 12:00–1:30 pm		
1:30–3:00 pm	Session 25 TeraHertz Technologies	Session 26 Ultra Low Power Silicon Electronics	Session 27 Wide-Bandgap Oxide Optoelectronics and Devices	1:30–3:00 pm			